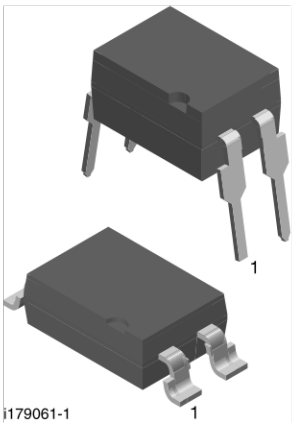
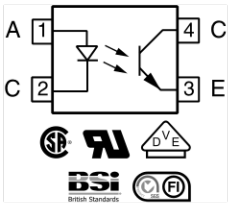
Optocoupler, Phototransistor Output, Low Input Current





FEATURES

- Good CTR linearity depending on forward current
- Low CTR degradation
- High collector emitter voltage, V_{CEO} = 55 V
- Isolation test voltage, 5300 V_{RMS}
- Low coupling capacitance
- End stackable, 0.100" (2.54 mm) spacing
- High common mode transient immunity
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

Pb-free

e3

RoHS COMPLIANT

APPLICATIONS

- Telecom
- Industrial controls
- Battery powered equipment
- Office machines

AGENCY APPROVALS

- UL1577, file no. E52744 system code H or J, double protection
- CSA 93751
- DIN EN 60747-5-2 (VDE 0884) available with option 1
- BSI IEC60950; IEC60065
- FIMKO

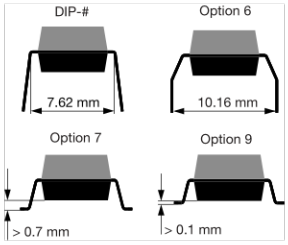
DESCRIPTION

The SFH618A (DIP) and SFH6186 (SMD) feature a high current transfer ratio, low coupling capacitance and high isolation voltage. These couplers have a GaAs infrared diode emitter, which is optically coupled to silicon planar phototransistor detector, and is incorporated in a plastic DIP-4 or SMD package.

The coupling devices are designed for signal transmission between two electrically separated circuits.The couplers are end-stackable with 2.54 mm lead spacing. Creepage and clearance distances of > 8 mm achieved with option 6. This version complies with IEC 60950 (DIN VDE 0805) for reinforced insulation to an operation voltage of 400 V_{RMS} or DC.

ORDERING INFORMATION

S	F	H	6	1	8	#	-	#	X	0	#	#	T
PART NUMBER								CTR BIN	PACKAGE OPTION				TAPE AND REEL



AGENCY CERTIFIED/PACKAGE	CTR (%) 1 mA			
UL, CUL	**63 to 125**	**100 to 200**	**160 to 320**	**250 to 500**
DIP-4	SFH618A-2	SFH618A-3	SFH618A-4	SFH618A-5
DIP-4, 400 mil, option 6	-	SFH618A-3X006	-	-
SMD-4, option 7	-	-	-	SFH618A-5X007T (1)
SMD-4, option 9	SFH6186-2T (1)	SFH6186-3T (1), SFH6186-3X002T (1)	SFH6186-4T (1)	SFH6186-5T (1), SFH6186-5T1 (2)
VDE, UL, CUL	**63 to 125**	**100 to 200**	**160 to 320**	**250 to 500**
DIP-4	-	SFH618A-3X001	SFH618A-4X001	-
DIP-4, 400 mil, option 6	-	SFH618A-3X016	SFH618A-4X016	SFH618A-5X016
SMD-4, option 7	-	SFH618A-3X017	-	SFH618A-5X017T (1)
SMD-4, option 9	-	SFH6186-3X001T (1)	SFH6186-4X001T	SFH6186-5X001T (1)

Notes

- Additional options may be possible, please contact sales office

(1) Also available in tubes, do not put T to the end

(2) Product is rotated 180° in tape and reel cavity

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)				
PARAMETER	**TEST CONDITION**	**SYMBOL**	**VALUE**	**UNIT**
INPUT				
Reverse voltage		V_R	6	V
Power dissipation		P_{diss}	70	mW
Forward current		I_F	60	mA
OUTPUT				
Collector emitter voltage		V_{CEO}	55	V
Emitter collector voltage		V_{ECO}	7	V
Collector current		I_C	50	mA
	$t_p \leq 1$ ms	I_C	100	mA
Power dissipation		P_{diss}	150	mW
COUPLER				
Isolation test voltage between emitter and detector		V_{ISO}	5300	V_{RMS}
Isolation resistance	V_{IO} = 500 V, T_{amb} = 25 °C	R_{IO}	$\geq 10^{12}$	Ω
	V_{IO} = 500 V, T_{amb} = 100 °C	R_{IO}	$\geq 10^{11}$	Ω
Storage temperature range		T_{stg}	- 55 to + 150	°C
Ambient temperature range		T_{amb}	- 55 to + 100	°C
Junction temperature		T_j	100	°C
Soldering temperature (1)	max. 10 s, dip soldering distance to seating plane ≥ 1.5 mm	T_{sld}	260	°C

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

(1) Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

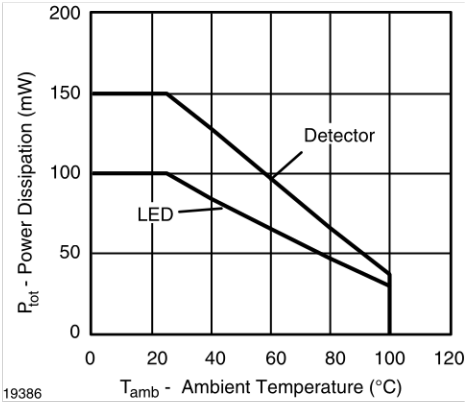


Fig. 1 - Permissible Power Dissipation vs. Ambient Temperature

ELECTRICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)							
PARAMETER	**TEST CONDITION**	**PART**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
INPUT							
Forward voltage	I_F = 5 mA		V_F		1.1	1.5	V
Reverse current	V_R = 6 V		I_R		0.01	10	µA
Capacitance	V_R = 0 V, f = 1 MHz		C_O		25		pF
Thermal resistance			R_{thja}		1070		K/W
OUTPUT							
Collector emitter leakage current	V_{CE} = 10 V		I_{CEO}		10	200	nA
Collector emitter capacitance	V_{CE} = 5 V, f = 1 MHz		C_{CE}		7		pF
Thermal resistance			R_{thja}		500		K/W
COUPLER							
Collector emitter saturation voltage	I_C = 0.32 mA, I_F = 1 mA	SFH618A-2	V_{CEsat}		0.25	0.4	V
		SFH6186-2	V_{CEsat}		0.25	0.4	V
	I_C = 0.5 mA, I_F = 1 mA	SFH618A-3	V_{CEsat}		0.25	0.4	V
		SFH6186-3	V_{CEsat}		0.25	0.4	V
	I_C = 0.8 mA, I_F = 1 mA	SFH618A-4	V_{CEsat}		0.25	0.4	V
		SFH6186-4	V_{CEsat}		0.25	0.4	V
	I_C = 1.25 mA, I_F = 1 mA	SFH618A-5	V_{CEsat}		0.25	0.4	V
		SFH6186-5	V_{CEsat}		0.25	0.4	V
Coupling capacitance			C_C		0.25		pF

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

CURRENT TRANSFER RATIO (T_{amb} = 25 °C, unless otherwise specified)							
PARAMETER	**TEST CONDITION**	**PART**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
I_C/I_F	I_F = 1 mA, V_{CE} = 0.5 V	SFH618A-2	CTR	63		125	%
		SFH6186-2	CTR	63		125	%
	I_F = 0.5 mA, V_{CE} = 1.5 V	SFH618A-2	CTR	32	75		%
		SFH6186-2	CTR	32	75		%
	I_F = 1 mA, V_{CE} = 0.5 V	SFH618A-3	CTR	100		200	%
		SFH6186-3	CTR	100		200	%
	I_F = 0.5 mA, V_{CE} = 1.5 V	SFH618A-3	CTR	50	120		%
		SFH6186-3	CTR	50	120		%
	I_F = 1 mA, V_{CE} = 0.5 V	SFH618A-4	CTR	160		320	%
		SFH6186-4	CTR	160		320	%
	I_F = 0.5 mA, V_{CE} = 1.5 V	SFH618A-4	CTR	80	200		%
		SFH6186-4	CTR	80	200		%
	I_F = 1 mA, V_{CE} = 0.5 V	SFH618A-5	CTR	250		500	%
		SFH6186-5	CTR	250		500	%
	I_F = 0.5 mA, V_{CE} = 1.5 V	SFH618A-5	CTR	125	300		%
		SFH6186-5	CTR	125	300		%

SWITCHING CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Turn on time	V_{CC} = 5 V, I_C = 2 mA, R_L = 100 Ω	t_{on}		6		µs
Rise time	V_{CC} = 5 V, I_C = 2 mA, R_L = 100 Ω	t_r		3.5		µs
Turn off time	V_{CC} = 5 V, I_C = 2 mA, R_L = 100 Ω	t_{off}		5.5		µs
Fall time	V_{CC} = 5 V, I_C = 2 mA, R_L = 100 Ω	t_f		5		µs

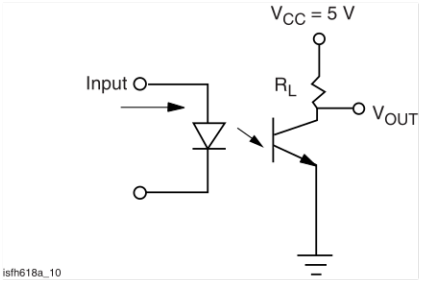


Fig. 2 - Test Circuit

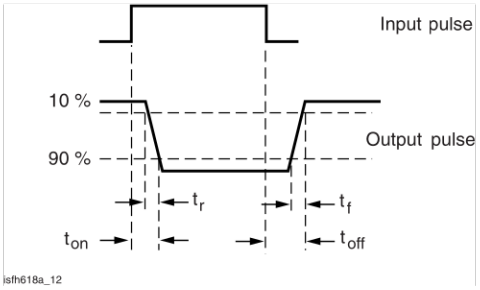


Fig. 3 - Test Circuit and Waveforms

SAFETY AND INSULATION RATINGS						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Climatic classification (according to IEC68 part 1)				55/100/21		
Comparative tracking index		CTI	175		399	
V_{IOTM}			10000			V
V_{IORM}			890			V
P_{SO}					400	mW
I_{SI}					275	mA
T_{SI}					175	°C
Creepage distance	Standard DIP-4		7			mm
Clearance distance	Standard DIP-4		7			mm
Creepage distance	400 mil DIP-4		8			mm
Clearance distance	400 mil DIP-4		8			mm
Insulation thickness, reinforced rated	per IEC60950 2.10.5.1		0.4			mm

Note

- As per IEC60747-5-2, § 7.4.3.8.1, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

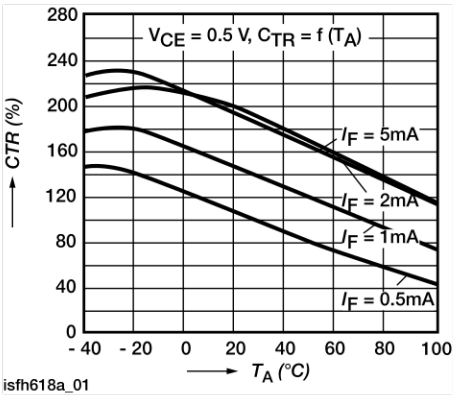


Fig. 4 - Current Transfer Ratio (typ.)

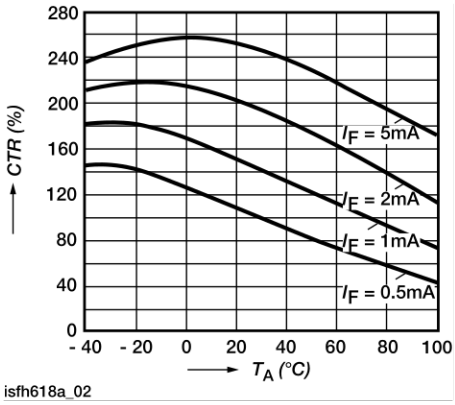


Fig. 5 - Current Transfer Ratio (typ.)

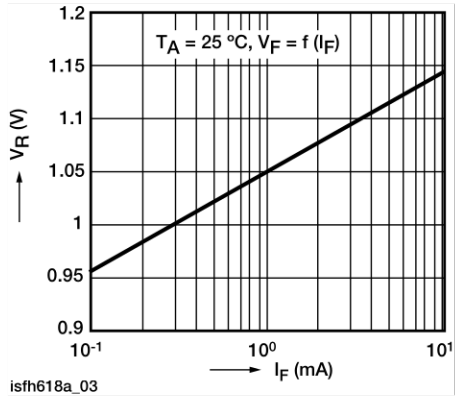


Fig. 6 - Diode Forward Voltage (typ.)

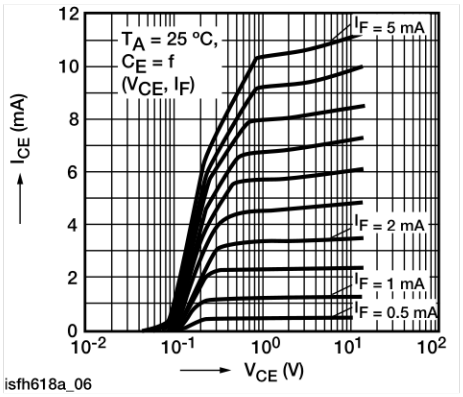


Fig. 9 - Output Characteristics

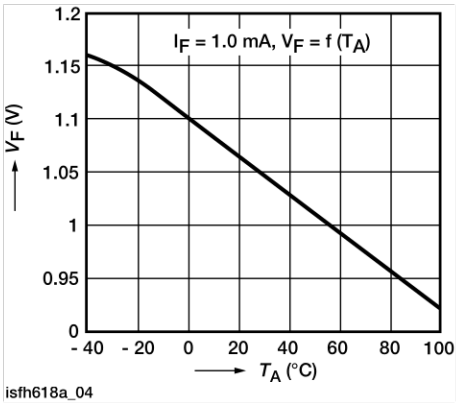


Fig. 7 - Diode Forward Voltage (typ.)

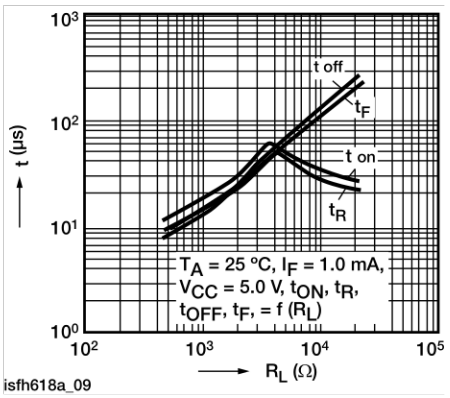


Fig. 10 - Switching Times (typ.)

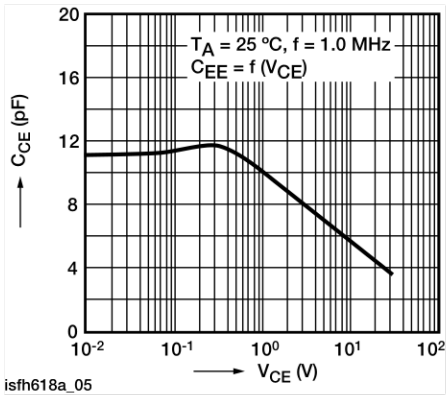
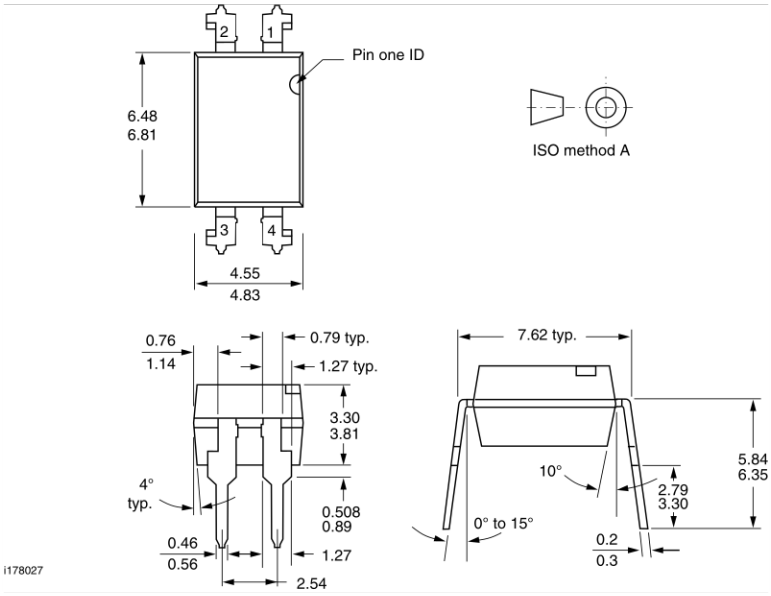
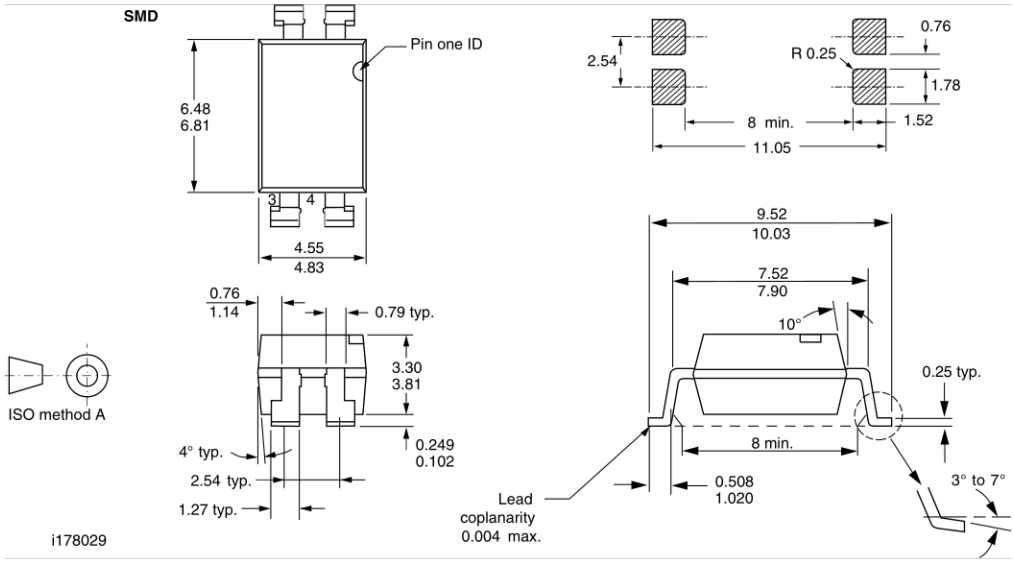
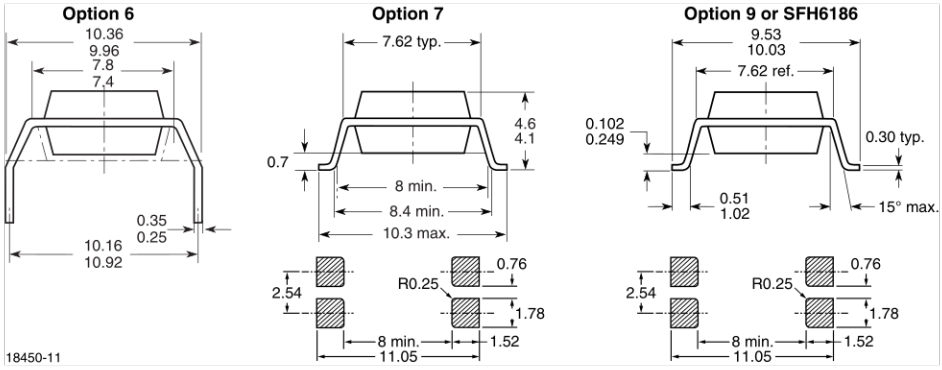


Fig. 8 - Transistor Capacitance

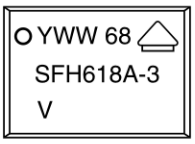
PACKAGE DIMENSIONS in millimeters







PACKAGE MARKING



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